506980048 11/16/2021 PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7026887

SUBMISSION TYPE:		NEW ASSIGNMENT				
NATURE OF CONVEYANCE:		ASSIGNMENT				
CONVEYING PARTY D	ΑΤΑ					
		Name	Execution Date			
SVXR, INC.			09/09/2021			
RECEIVING PARTY DA	ATA					
Name:	BRUKER NA	NO, INC.				
Street Address:	112 ROBIN F	DBIN HILL ROAD				
City:	SANTA BARI	BARA				
State/Country:	CALIFORNIA	DRNIA				
Postal Code:	93117					
PROPERTY NUMBERS	S Total: 28		_			
Property Type		Number				
Application Number:	16786	912				
Application Number:	16874	248				
Application Number:	16830	0108				
Application Number:	16924	581				
Application Number:	16924	645				
Application Number:	16924	663				
Application Number:	16924	706				
Application Number:	16924	1747				
Application Number:	63062	2299				
Patent Number:	91297	/15				
Patent Number:	96077	/24				
Patent Number:	96467	/32				
Patent Number:	10559	0396				
Patent Number:	10692	2184	7			
Patent Number:	11055	5821	7			
Patent Number:	11042	2981	7			
Application Number:	17394	357	7			
Application Number:	17339	0136	1			
Application Number:	17325	591	7			
PCT Number:	US20	33586	7			

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	1		-
Property Type		Number	
PCT Number:	US20	032698	
PCT Number:	US20	041508	
PCT Number:	US20)41514	
PCT Number:	US20)41520	
PCT Number:	US20)41527	
PCT Number:	US20)41536	
PCT Number:	US20)41546	
PCT Number:	US21	44668	
CORRESPONDENCE DATA			
Fax Number:	(414)2	225-9753	
		e-mail address first; if that is un nat is unsuccessful, it will be se	
Phone:	41422	259755	
Email:	docke	eting@boylefred.com	
Correspondent Name:	JAY (G. DURST	
Address Line 1:	840 N	I. PLANKTINTON AVE	
Address Line 4:	MILW	AUKEE, WISCONSIN 53203	
ATTORNEY DOCKET NUMBER	:	7528.000	
NAME OF SUBMITTER:		JAY G. DURST	
SIGNATURE:		/Jay G. Durst/	
DATE SIGNED:		11/16/2021	
Total Attachments: 9			
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INTELLECTUAL PROPERTY ASSIGNMENT

This Intellectual Property Assignment (this "Assignment") is made as of September 9, 2021, by and between SVXR, INC., a Delaware corporation (the "Assignor") as assignor, and BRUKER NANO, INC., an Arizona corporation (the "Assignee"), as assignee.

RECITALS

- A. The Assignor and Assignee have entered into that certain Asset Purchase Agreement dated as of August 3, 2021 (the "*Purchase Agreement*"), pursuant to the terms of which Assignor agreed to assign the Acquired Intellectual Property to Assignee, which includes, without limitation, the Intellectual Property set forth on <u>Exhibit A</u> attached hereto (collectively the "*IP*");
- B. Capitalized terms not otherwise defined herein shall have the meanings ascribed to them in the Purchase Agreement; and
- C. Pursuant to the terms of the Purchase Agreement, the Assignor and Assignee desire to enter into this Assignment.

AGREEMENT

NOW, THEREFORE, in consideration of the foregoing recitals and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the parties agree as follows:

1. Assignor hereby sells, assigns, transfers, conveys, and delivers to Assignee its entire right, title and interest in and to the IP, together with all rights, licenses and other agreements, if any, heretofore made by Assignor in respect of, or relating to, the IP, all goodwill associated therewith, all common law rights therein, and all income, royalties, rights to prepare derivative works, fees and payments, if any, now or hereafter due or payable in respect to the IP, including any rights to file an action and recover damages by reason of past infringement, misappropriation or other unauthorized use of the IP, with a right to sue for, and collect the same for its own use and behalf, and for the use and behalf of its successors, assigns, or other legal representatives.

2. Assignee hereby accepts Assignor's assignment and transfer of the IP.

3. Assignor shall execute, acknowledge and deliver to Assignee all documents, instruments and agreements as may be necessary to make a record with any governmental authority (both foreign and domestic) or third parties of this Assignment and Assignee's ownership of all right, title and interest in, to and under the IP.

4. The execution and delivery of this Assignment shall not, in any way, affect, limit, supersede, modify, replace, amend, change, rescind, waive or exceed the rights and obligations of Assignor and Assignee under, or enlarge, restrict or otherwise modify the terms of the Purchase Agreement, including the warranties, covenants, agreements, conditions, representations or, in general any of the rights and remedies, and any of the obligations and indemnifications of any party set forth in the Purchase Agreement. In the event of any conflict or inconsistency between

PATENT REEL: 058125 FRAME: 0372

the terms of the Purchase Agreement and the terms hereof, the terms of the Purchase Agreement shall govern.

5. Should any term or provision of this Assignment be held to any extent unenforceable, invalid, or prohibited under law, then such provision shall be deemed restated to reflect the original intention of the parties as nearly as possible in accordance with applicable law and the remainder of this Assignment. The application of such term or provision to persons, property, or circumstances other than those as to which it is invalid, unenforceable, or prohibited, shall not be affected by such invalidity, unenforceability, or prohibition, and each term and provision of this Assignment shall be valid and enforceable to the fullest extent permitted by law. This Assignment may not be amended except by execution and delivery of an instrument in writing signed by officers of Assignor and Assignee.

6. This Assignment and all of the provisions in this Assignment shall be binding upon and inure to the benefit of the successors in interest and assigns of the parties.

7. This Assignment shall be governed by, and construed and interpreted in accordance with the laws of the State of Delaware applicable to agreements made and to be performed entirely within such state, but excluding the conflicts of laws principles thereof.

8. Subject to Section 4 above, this Assignment constitutes the complete and exclusive statement of the agreement between the parties with respect to the subject matter of this Assignment, and this Assignment supersedes any prior oral or written communications, proposals, representations, and agreements. This Assignment and the obligations hereunder are not intended to confer any rights or remedies to any third party and are not intended to operate, in anyway, as an agreement for the benefit of any third party.

9. This Assignment may be executed in counterparts, each of which shall be deemed an original, but all of which together shall constitute one and the same instrument. An executed counterpart of this Assignment transmitted and received by facsimile or PDF shall be deemed for all purposes to be an original, executed counterpart hereof.

[Remainder of Page Intentionally Left Blank]

IN WITNESS WHEREOF, the Assignor and Assignee have executed this Assignment as of the day and year first above written.

ASSIGNOR:

SVXR, INC.

By: David P. Inpanier Name: Dan Trepanier Title: Chief Executive Officer

ASSIGNEE:

BRUKER NANO, INC.

[Signature Page to Intellectual Property Assignment]

PATENT REEL: 058125 FRAME: 0374 IN WITNESS WHEREOF, the Assignor and Assignee have executed this Assignment as of the day and year first above written.

ASSIGNOR:

SVXR, INC.

By: Name: Dan Trepanier Title: Chief Executive Officer

ASSIGNEE:

BRUKER NANO, INC.

-----DocuSigned by:

By: <u>Mark Munch</u> Name: Mark Wunch, Ph.D. Title: President

[Signature Page to Intellectual Property Assignment]

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<u>Exhibit A</u>

See Attached.

Exhibit A

Intellectual Property

<u>(a)</u>

Patents:

Attached as Attachment 6.16(a).

Domains:

(a) svxr.com; and (b) svxr.org

Trademarks:

MARK	JUR.	REG. #/ APP#	IC	GOODS/SERVICES	REG. DATE
X200	USA	90284327	009	Downloadable industrial process control software; Electro-optical instruments for use in inspection and measurement of industrial components; Industrial X-ray apparatus in the nature of testing equipment for determining industrial flaws; Instruments for detecting and measuring two-dimensional distribution of force and pressure; Water testing instrumentation for monitoring and detecting contamination; X-ray apparatus not for medical purposes.	Filing Date: October 28, 2020

MARK	JUR.	REG. #/ APP#	IC	GOODS/SERVICES	REG. DATE
5V% ?	USA	90278931	009	Downloadable industrial process control software; Electro-optical instruments for use in inspection and measurement of industrial components; Industrial X-ray apparatus in the nature of testing equipment for determining industrial flaws; Instruments for detecting and measuring two-dimensional distribution of force and pressure; Water testing instrumentation for monitoring and detecting contamination; X-ray apparatus not for medical purposes.	Filing Date: October 26, 2020

The Paychex Agreement (as defined below) (Paychex IP licensed to Seller).

The Cimetrix Agreement (as defined below) (Cimetrix IP licensed to Seller).

The Varex Agreement (as defined below) (Varex IP licensed to Seller, and Seller IP licensed to Varex).

The Micron Agreement (Seller IP licensed to Micron to the extent Seller provides Seller software to Micron under a SOW).

Collaboration and Joint Development Agreement, dated as of March 18, 2019, by and between the Company and Advance Semiconductor Engineering, Inc. and the statements of work thereto ("ASE JDP") (Seller IP licensed to ASE, and ASE IP licensed to Seller).

Master Services Agreement, dated as of September 27, 2018, by and between the Company and SSS Group, Inc. and the statements of work thereto ("SSS Agreement") (SSS IP licensed to Seller).

Master Services Agreement, dated as of January 10, 2021, by and among the Company and Papaya Global Inc. and Papaya Global (HK) Limited; Software as a Service (Saas) License Agreement, dated as of January 10, 2021, by and among the Company and Papaya Global Inc. (the "**Papaya Global Agreements**") (Papaya IP licensed to Seller).

Capital Purchase Agreement, dated as of September 20, 2018, by and between the Company and Avago Technologies, Inc. (the "**Broadcom Agreement**") (Seller IP licensed to Broadcom).

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Venue Terms and Conditions of Service, by and between the Company and Donnelley Financial LLC (the "DFIN Agreement") (Donnelley IP licensed to Seller).

<u>(b)</u>

The Company uses the following "open source" software: (a) BitMiracle.LibTiff.Net, (b) Json.Net, (c) Math.net, (d) OpenCvSharp, (e) OpenCV, and (f) MongoDB.

	A	В	С	D	Е	F	G	Н
	Status	Country	Application No.	Filing Date	Patent No.	Issue Date	Title	Published App.
1		-						Number
2	Pending	US	16/786912	2/10/2020			Devices Processed Using X-Rays	
	Pending	TW	108123714	7/5/2019			Super-Resolution X-ray Imaging Method and Apparatus	
3	_							
	Pending	US	16/874,248	5/14/2020			Method and Apparatus for Rapid Inspection of	20200380664
4							Subcomponents of Manufactured Component	
	Pending	PCT	PCT/US20/33586	5/19/2020	•	-	Method and Apparatus for Rapid Inspection of	
5							Subcomponents of Manufactured Component	
	Pending	тw	109118092	5/29/2020			Method and Apparatus for Rapid Inspection of	
6							Subcomponents of Manufactured Component	
_	Pending	US	16/830,108	3/25/2020			Method and Apparatus Rapidly Classifying Defects in	20200380654
7			DOT# 1000/00000	5400000			Subcomponents of Manufactured Component	
~	Pending	PCT	PCT/US20/32698	5/13/2020		-	Method and Apparatus Rapidly Classifying Defects in	
8	De sali se	714/	400440004	5/00/0000			Subcomponents of Manufactured Component	
9	Pending	тw	109118091	5/29/2020			Method and Apparatus Rapidly Classifying Defects in	
9	Dendina	us	40/004504	7/0/0000			Subcomponents of Manufactured Component	20240042400
10	Pending	05	16/924581	7/9/2020			Methods and Systems for Detecting Defects in Devices Using X-rays	20210012499
	Pending	РСТ	PCT/US20/41508	7/10/2020			Using X-rays	
	Pending	TW	109123429	7/10/2020			Methods and Systems for Detecting Defects in Devices	
12	Penuing		109123429	1/10/2020			Using X-rays	
12	Pending	US	16/924645	7/9/2020			Methods and Systems for Defects Detection and	20210010953
13	renuing	03	10/924043	119/2020			Classification Using X-rays	20210010933
	Pending	РСТ	PCT/US20/41514	7/10/2020				
17	Pending	TW	109123431	7/10/2020			Methods and Systems for Defects Detection and	
15	, on only		100120101				Classification Using X-rays	
	Pending	US	16/924663	7/9/2020			Methods and Systems for Process Control Based on X-	20210011177
16							ray Inspection	
	Pending	PCT	PCT/US20/41520	7/10/2020			···· / ································	
	Pending	TW	109123432	7/10/2020			Methods and Systems for Process Control Based on X-	
18							ray Inspection	
	Pending	US	16/924706	7/9/2020			Methods and Systems for Product Failure Prediction	20210010954
19							based on X-ray Image Re-examination	
20	Pending	PCT	PCT/US20/41527	7/10/2020				
	Pending	TW	109123433	7/10/2020			Methods and Systems for Product Failure Prediction	
21							based on X-ray Image Re-examination	
	Pending	US	16/924747	7/9/2020			Methods and Systems for Manufacturing Printed Circuit	20210014979
22							Board based on X-ray Inspection	
23	Pending	PCT	PCT/US20/41536	7/10/2020				
. .	Pending	тw	109123434	7/10/2020			Methods and Systems for Manufacturing Printed Circuit	
24							Board based on X-ray Inspection	
	Pending	PCT	PCT/US20/41546	7/10/2020				
26	Pending	TW	109123435	7/10/2020				
07	Pending	US	63/062299	8/6/2020	-	-	Methods and Systems for Inspecting Integrated Circuits	
27			40/007000	0/4/0040	2622265	0/0/0017	Based on X-rays	
	Issued	US	13/987808		9129715		High Speed X-Ray Inspection Microscope Devices Processed Using X-Rays	
	Issued Issued	US US	14/732674 15/231774		9607724 0646722			
	Issued	US	15/231774		9646732 10559396		High Speed X-Ray Microscope Devices Processed Using X-Rays	
31	Issued	US	15/470726			6/22/2020	Super-Resolution X-ray Imaging Method and Apparatus	
32	ISSUED	03	10/03027	0/2/2018	<u>10692184</u>	0/23/2020	Super-Resolution A-ray imaging method and Apparatus	1
52	Issued	US	16/879073	5/20/2020	11055821		Super-Resolution X-ray Imaging Method and Apparatus	
33	100000	30		0,20,2020			Super-Resolution X-ray imaging Method and Apparatus	
	Issued	us	16/924769	7/9/2020	11042981		Methods and Systems for Printed Circuit Board Design	
34							Based on Automatic Corrections	

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